

PROCEEDINGS OF SPIE

*Industrial and Commercial
Applications of Smart Structures
Technologies 2011*

Kevin M. Farinholt
Steve F. Griffin
Editors

7-8 March 2011
San Diego, California, United States

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Published by
SPIE

Volume 7979

Proceedings of SPIE, 0277-786X, v. 7979

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Author(s), "Title of Paper," in *Industrial and Commercial Applications of Smart Structures Technologies 2011*, edited by Kevin M. Farinholt, Steve F. Griffin, Proceedings of SPIE Vol. 7979 (SPIE, Bellingham, WA, 2011) Article CID Number.

ISSN 0277-786X
ISBN 9780819485410

Published by

SPIE

P.O. Box 10, Bellingham, Washington 98227-0010 USA
Telephone +1 360 676 3290 (Pacific Time) · Fax +1 360 647 1445
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Printed in the United States of America.

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